

US00D561102S

(12) **United States Design Patent**
Taneno et al.

(10) **Patent No.:** **US D561,102 S**
(45) **Date of Patent:** **** Feb. 5, 2008**

(54) **SENSOR ATTACHMENT**

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(**) Term: **14 Years**

(21) Appl. No.: **29/220,180**

(22) Filed: **Jun. 14, 2004**

(51) **LOC (8) Cl.** **13-03**

(52) **U.S. Cl.** **D13/146; D13/133; D13/151**

(58) **Field of Classification Search** D13/133,
D13/146, 151, 154, 184; D10/49, 103, 122;
D16/219, 245, 241–242, 250; D8/349, 354,
D8/382, 387, 399, 499; 174/51 CC; 235/439,
235/454; 361/825; 439/92–93, 95–97
See application file for complete search history.

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(57) **CLAIM**

The ornamental design for a sensor attachment, as shown and described.

DESCRIPTION

FIG. 1 is a front elevation view illustrating our new design for a sensor attachment;

FIG. 2 is a top plan view thereof;

FIG. 3 is a bottom plan view thereof;

FIG. 4 is a left side elevation view thereof;

FIG. 5 is a top perspective view thereof; and,

FIG. 6 is a bottom perspective view thereof.

1 Claim, 3 Drawing Sheets

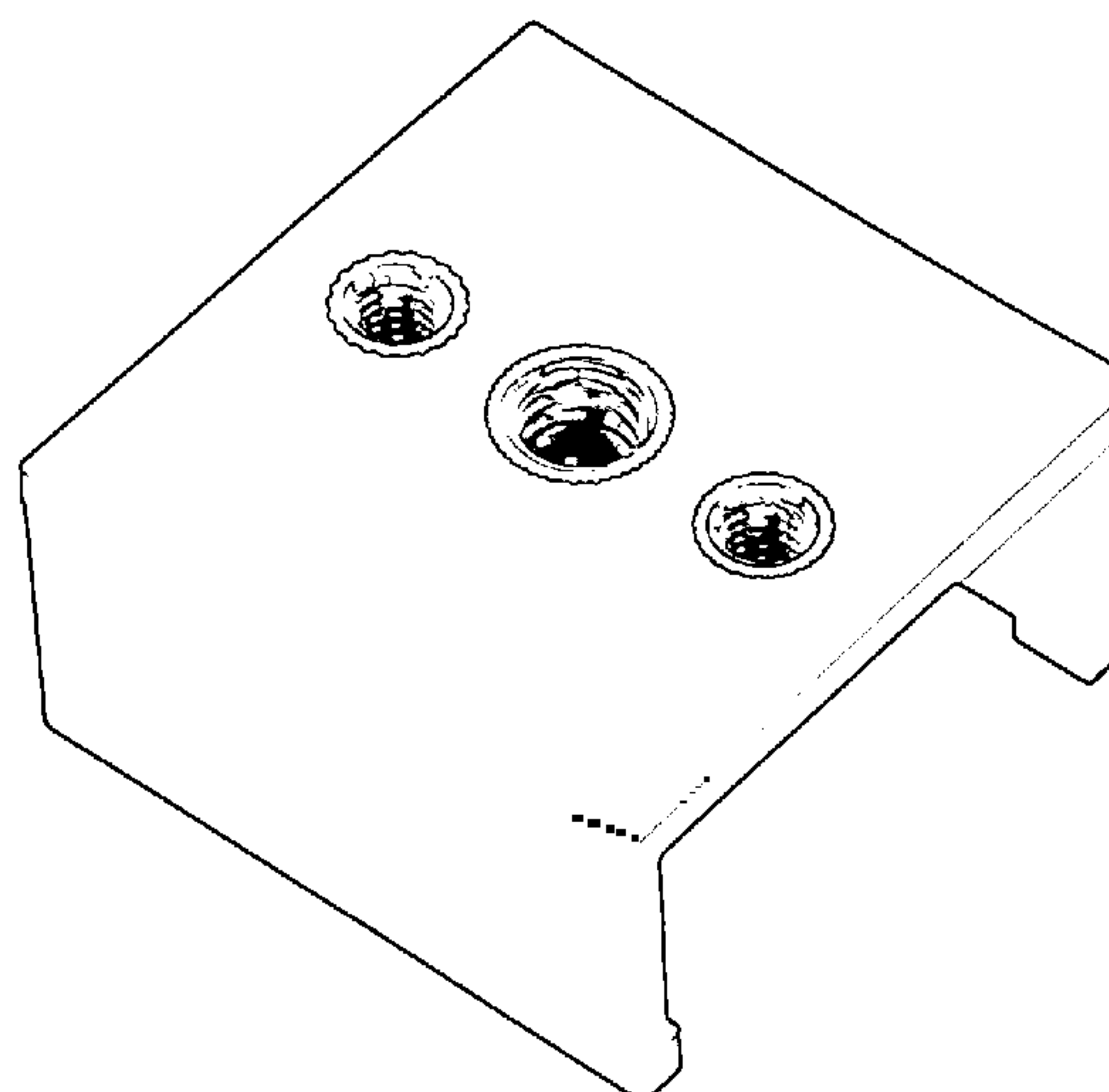
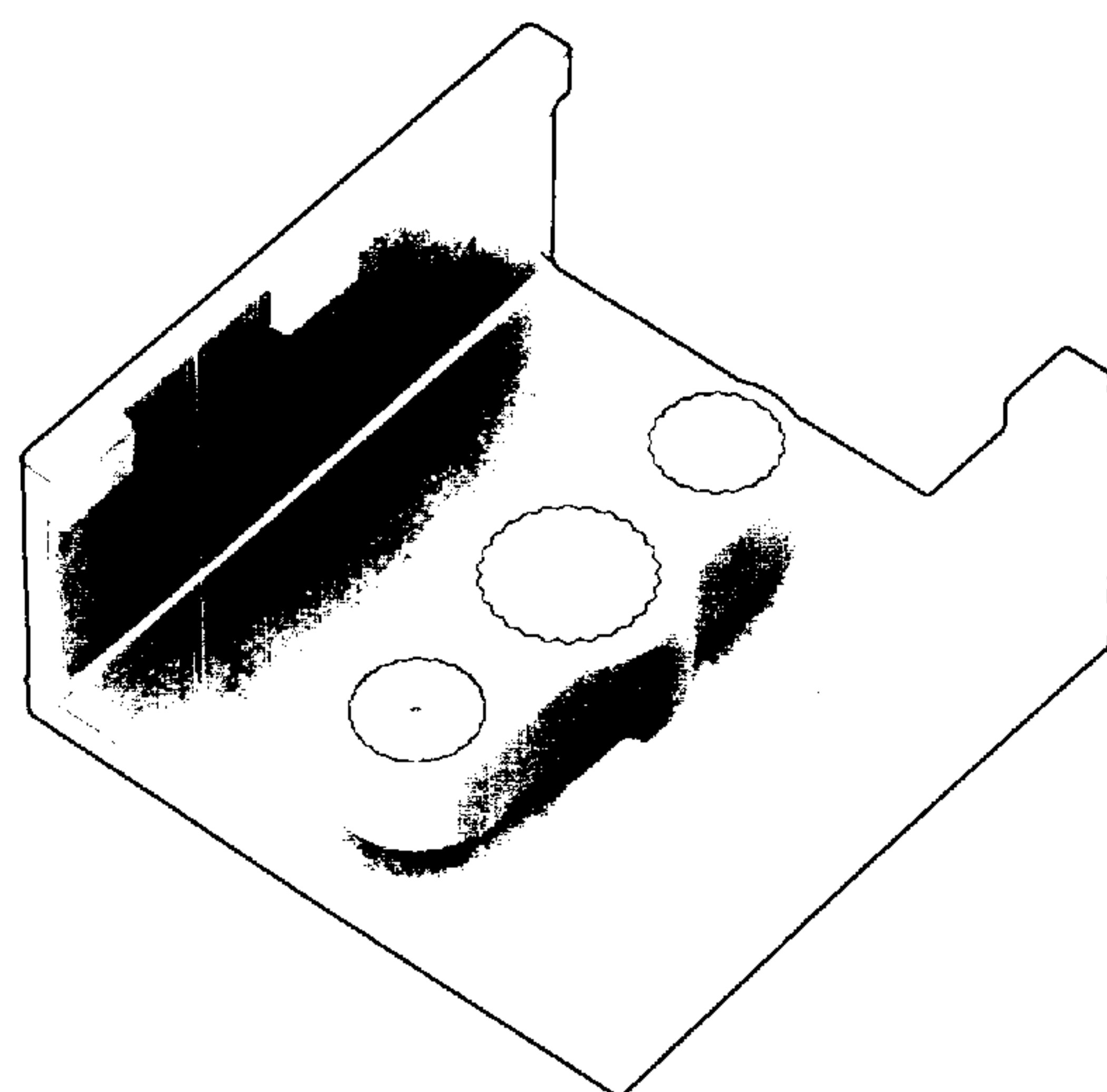


Fig.1

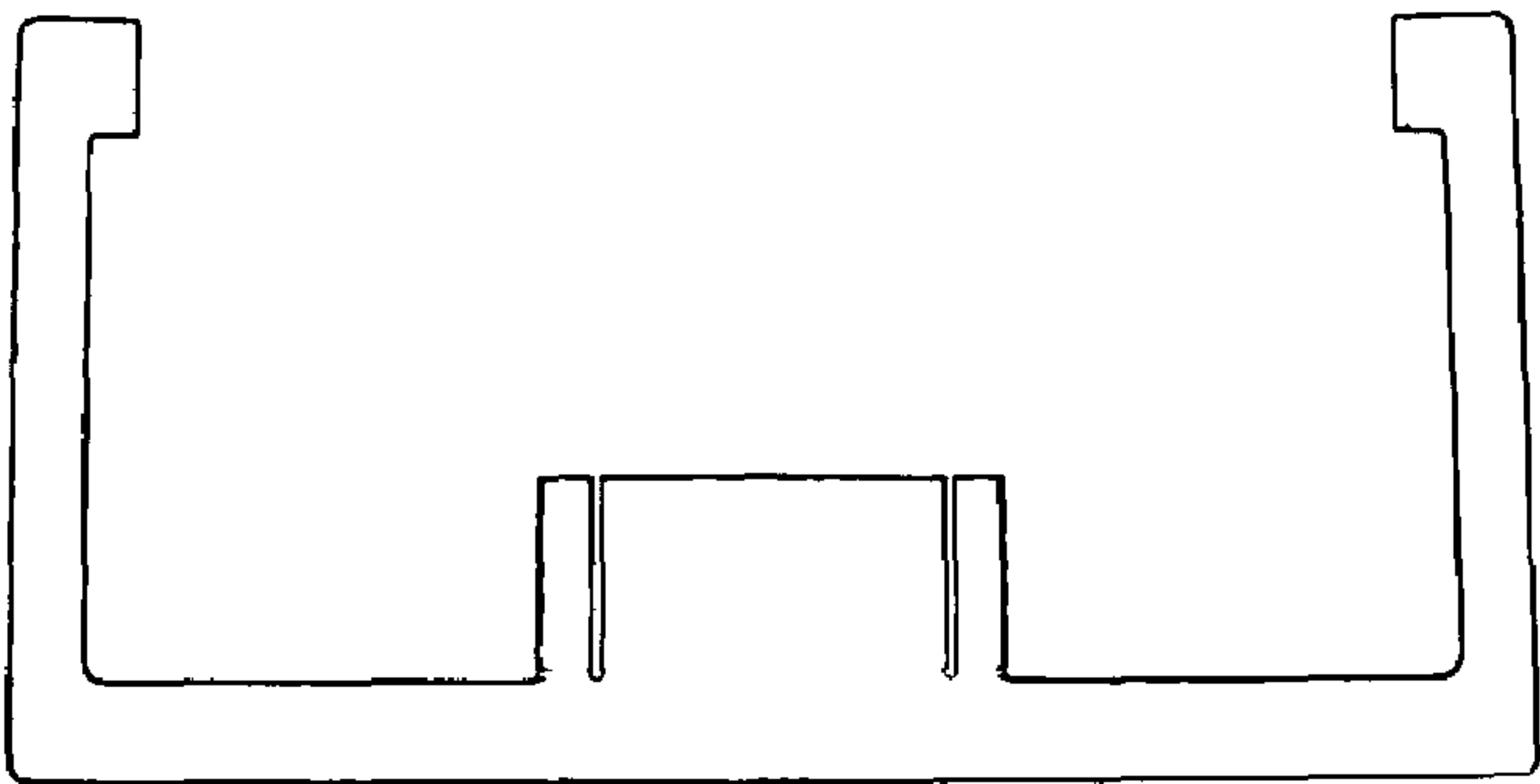


Fig.2

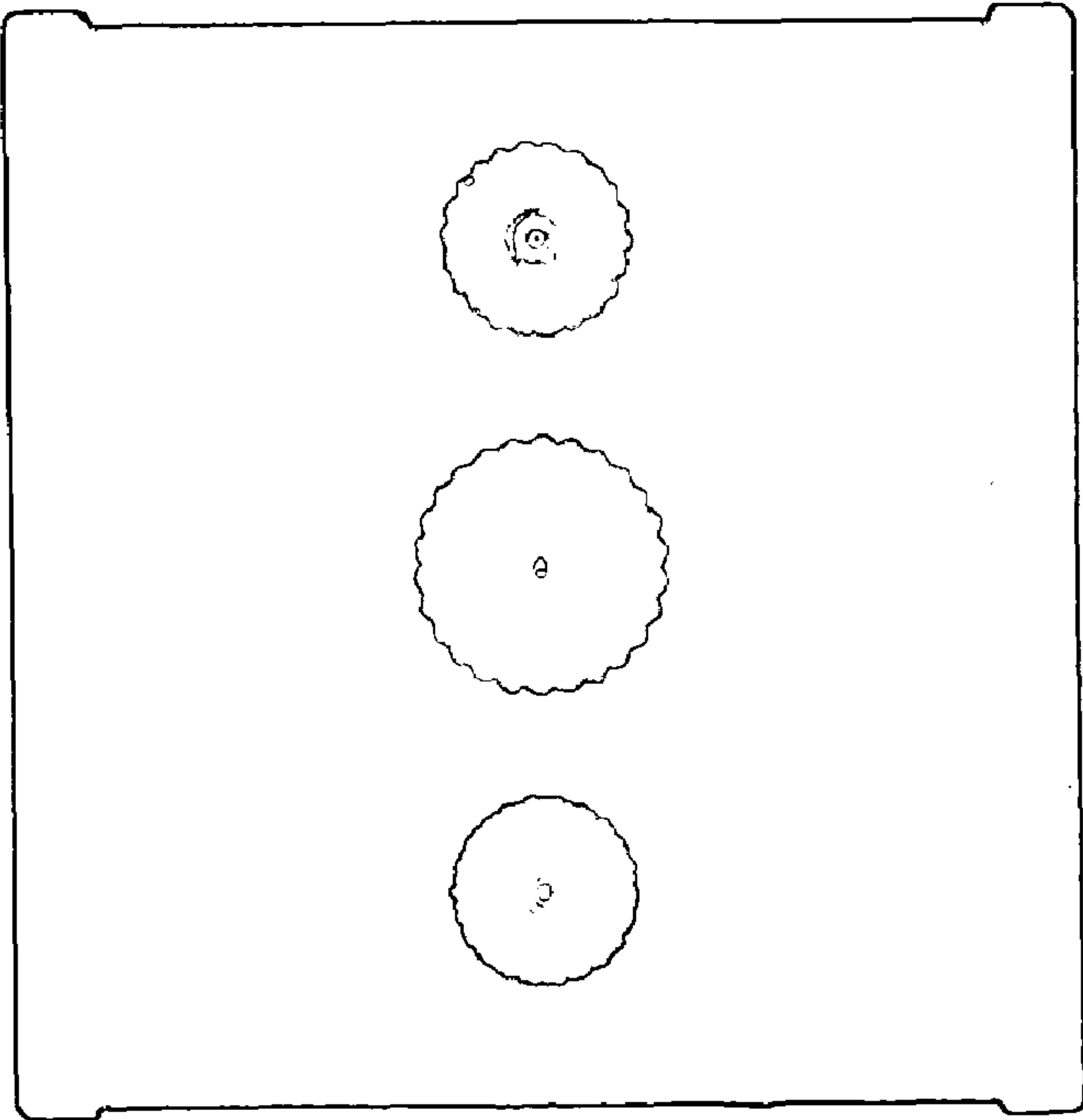


Fig.3

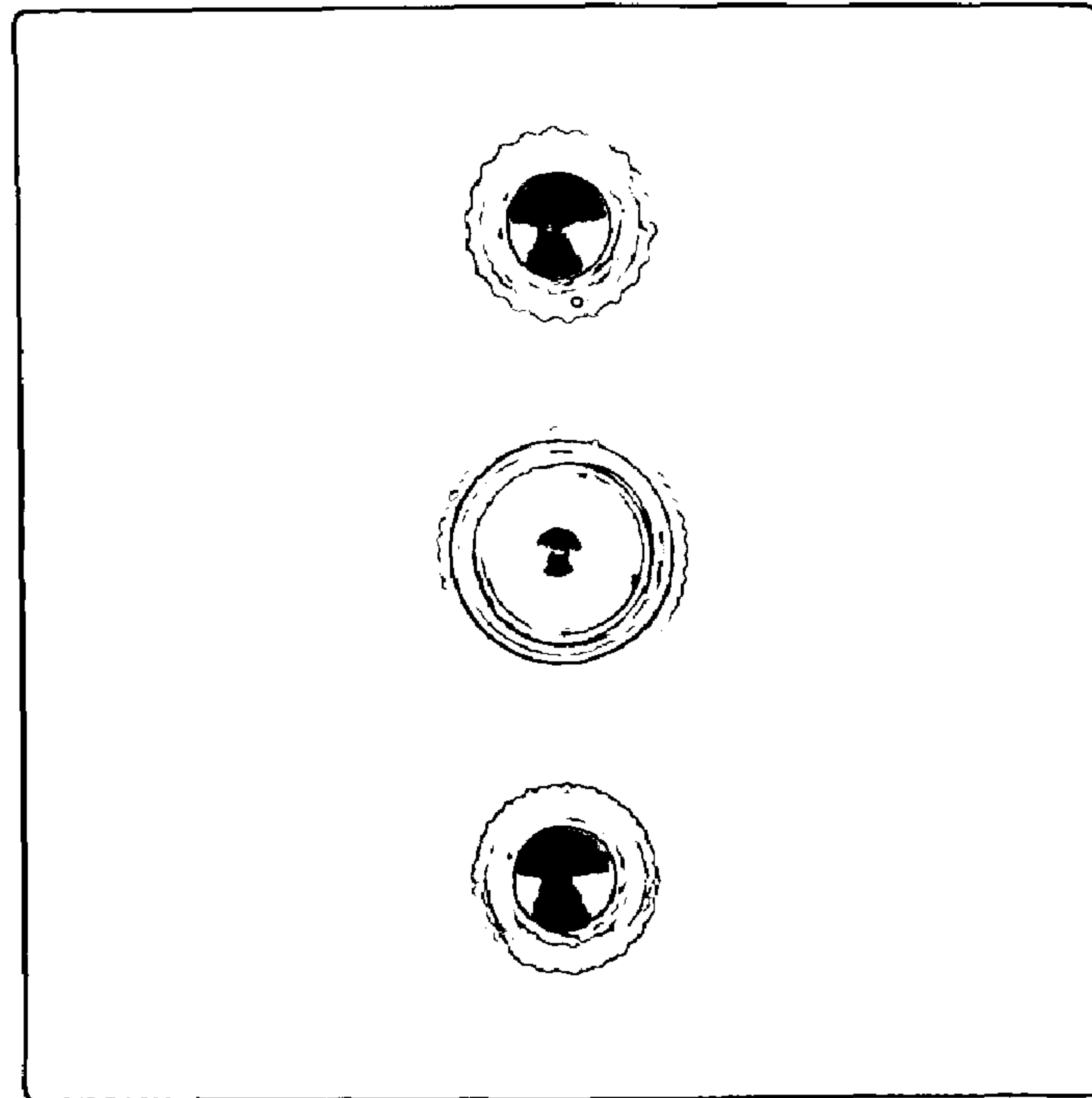


Fig.4

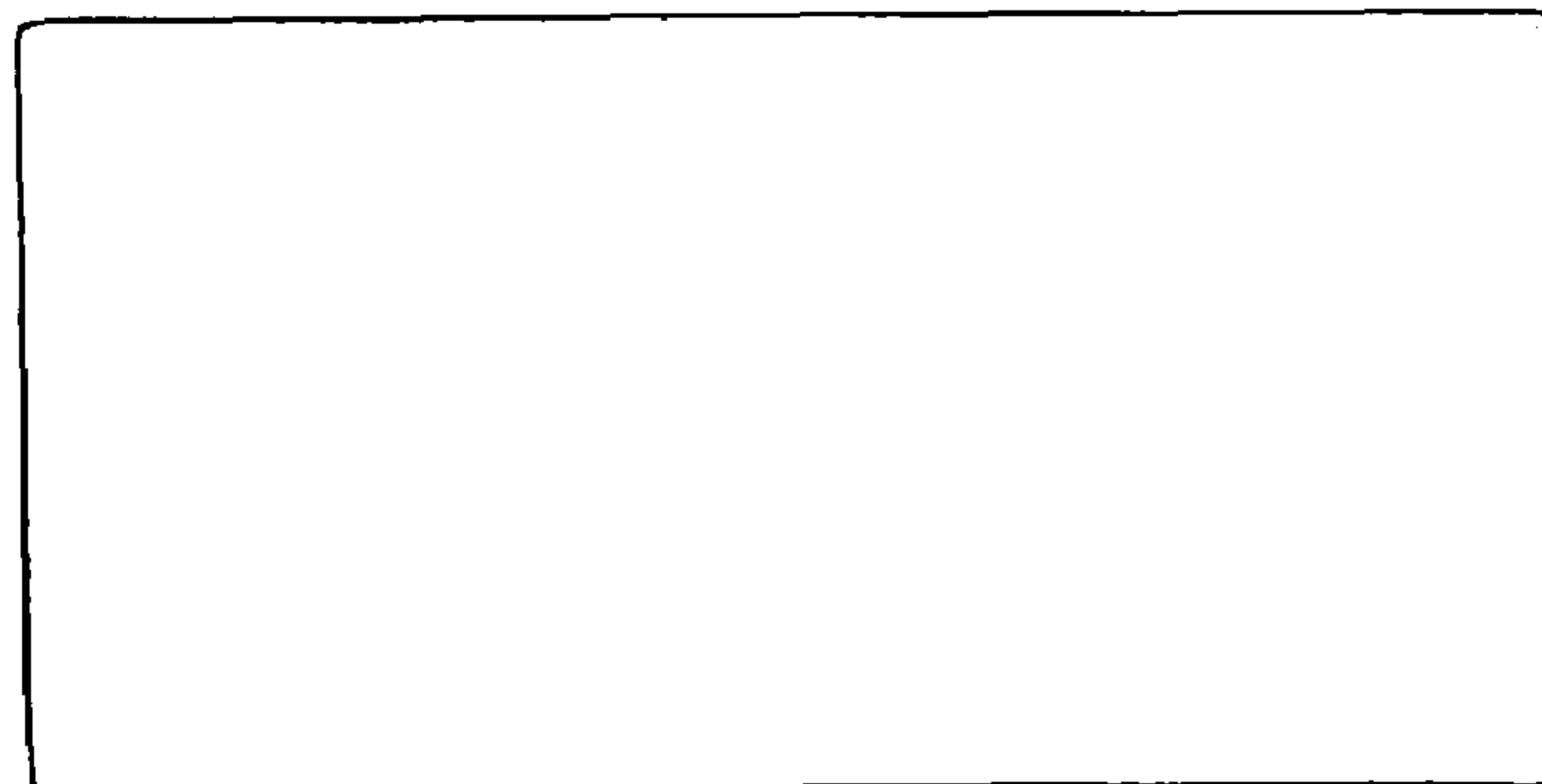


Fig.5

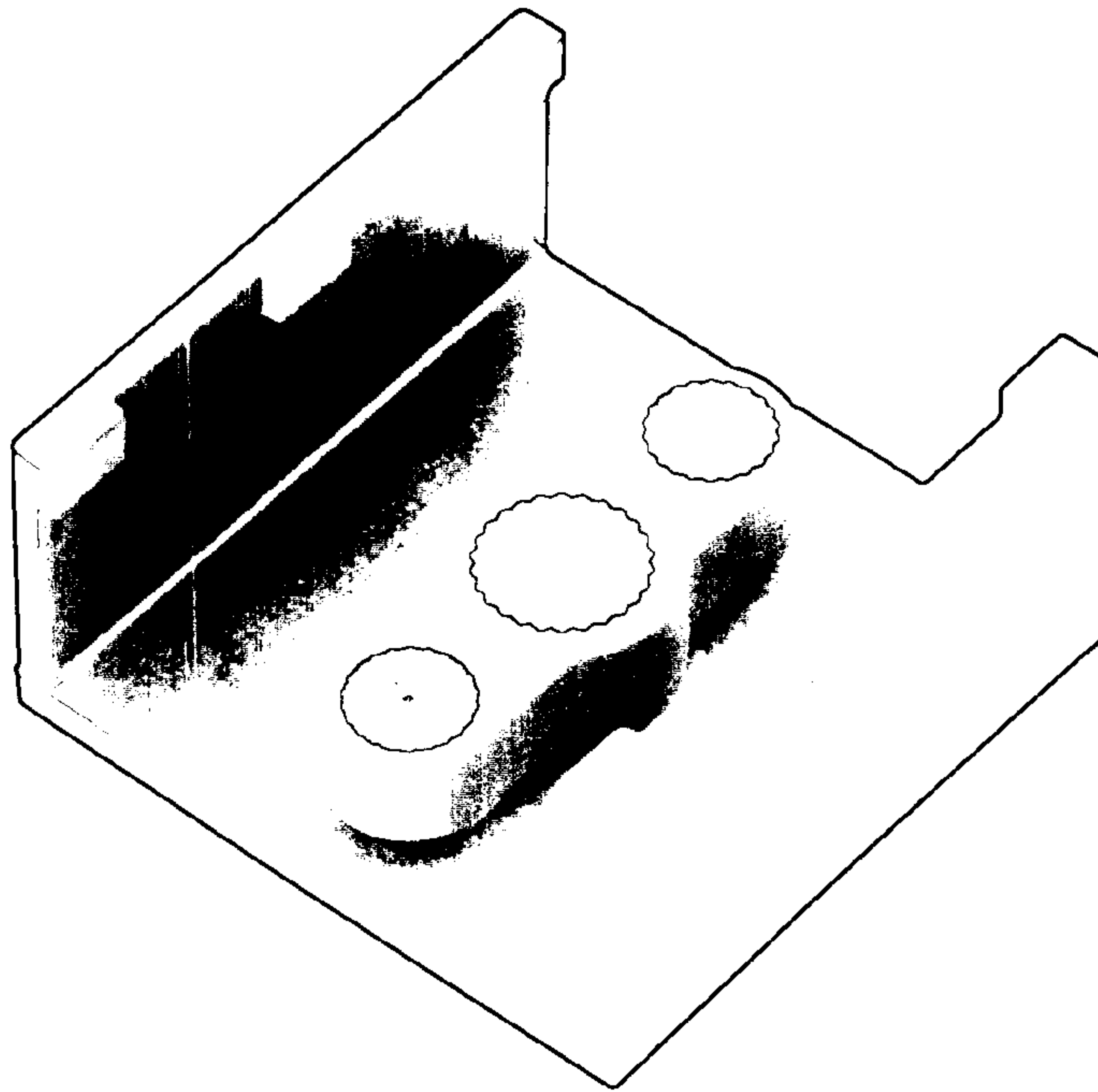


Fig.6

